Detailed Curriculum

Qualifications Pack	: PCB Design Engineer
SECTOR	: ELECTRONICS
SUB-SECTOR	: PCB Assembly
OCCUPATION	: PCB Design
REFERENCE ID	: ELE/Q8702
Role Description	: Assisting R&D to research on new products, working with systems
	designer to create initial designs, library management for component
	building, testing and finalizing design.
NVEQF/NVQF level	
Minimum Educational Qualifications	: Diploma
Maximum Educational Qualifications	: BE
Duration	: 250 Hrs

Outcome	Course Content	Hrs.
Acquire the basic level knowledge	Printed circuit Board Design:	
required to understand PCBs, history of		15
PWBs/PCBs, types of PCBs, basic	History of Printed Circuit Boards.	
electronics and components values,	Various types of Printed Circuit Boards-Single Sided	
polarities, packages of Electronic	Boards, Double Sided Plated through Hole Boards,	
components, SMD type components	multilayer Boards.	
and process of PCB design and product	Study of Packages of Electronic Components.	
development flow	Study of SMD Components.	
-	Process of PCB design and product development flow	
Understanding the flow of computer	Schematic Design:	15
aided design packages.	Study of PCB Design packages such as Or CAD, eagle,	
	PADs, PCB123 software for schematic capture, PCB	
Understand the rules before PCB	design and layout tools (any two).	
Designing.		
	Starting a project	
	 Working with schematic design tools 	
	Schematic drawing from circuit	
	Rules for PCB Design	
	 Standards for PCB Design 	
	 Placing, editing, and connecting parts and 	
	electrical symbols	
	 About libraries and parts 	
	 Creating a net list 	
	 Exporting and importing schematic data 	
	 Basic Circuit simulation using EDA tool 	

Acquire the importance of manufacturing	PCB Layout Design:	15
documents. Understanding how to design PCB for Manufacturing and assembly point of	Study of technical terms in layout design.	
view.	Board outline Design,	
	• components placement,	
	Details of layers,	
	Routing methods,	
	Copper Pour,	
	Adding reference texts,	
	Build library parts (footprints, schematic symbols)	
	Generation of various Manufacturing	
	Documents/Output files generation (Gerber file	
	generation)	
	IPC standards for printed circuit board design	
Acquire the basic level knowledge	PCB Manufacturing Techniques:	20
required to understand Film Master		
generation method, material used for manufacturing, cleaning methods of base	Fabrication methods	
material.	Film Master generation method :	
	Study of photographic Film, Exposing and Developing	
	Process.	
	Study of various material used in Manufacturing of Printed	
	Circuit Boards and properties of material.	
	Cleaning Method of base materials before pattern transfer-	
	Manual and Mechanical Cleaning Methods	
	Printed Circuit Board Manufacturing Methods :	20
	Method of Screen Printing for pattern transfer.	
Understand the methods for	Method of Wet film and Dry film for single and Double	
manufacturing of PCBS.	Sided Board Manufacturing.	
Type of material used for manufacturing.	Method of Solder-mask and Legend Printings.	
Understand the mechanical method in	Plating and Etching Techniques.	
manufacturing.	Mechanical methods required in manufacturing of PCBs like	
XX 1 . 1.1 1	punching, drilling, milling and routing.	1.5
Understand the basic concept fault	Study of-Fault Finding methods of PCBs,	15
finding /repair and rework methods	Repairing Techniques. De-soldering techniques, replacement of Component /Solder	
	Pad /Track repairing methods.	
Acquire the basic level knowledge	PCB Assembly Techniques :	20
required to understand assembly	Components Preparation Method-	20
techniques for leaded and SMDs.	Lead identification of components	
Acquire the basic level knowledge of use	Component mounting techniques	
of various tools during assembly.	Lead Forming methods.	
	Leaded through hole assembly and Surface Mount	
	Assembly.	
	Mixed Assembly Techniques of through hole and SMDs.	
	Manual Assembly method, Semiautomatic and automatic	
	Assembly method.	
	Study of Tools used in assembly process.	

Understand the methods of soldering of PCBs, material used in soldering process. Understand the methods of soldering.	Soldering Techniques: Materials used in Soldering Process. Types of soldering techniques. Soldering Methods –Manual and Mass soldering Techniques. Tools for soldering and de-soldering. Study of soldering defect and rectification.	15
Understand the basic concept of SMD Soldering and understand repair and rework methods	Testing for quality Control. Introduction to SMD soldering methods, placing methods of SMDs, study of material for SMD soldering. Rework and Repairing methods.	15
Practical/Tutorial	Based on theory- practical and Assignment in Design, Manufacturing and Assembly	100

Learning Outcome:

- > Students will acquire the basic level knowledge and will understand the packages of Electronic components, types of PCBs and history of PCBs.
- > Students will understand the rules before PCB Designing, the flow of computer aided design packages and will Acquire the importance of manufacturing documents (output file generation)
- ➤ Understand the basic concept of how to design PCB for Manufacturing and assembly point of view.
- Acquire the basic level knowledge required to understand Film Master Generation method, material used for manufacturing, cleaning methods of base material.
- > Understand the methods for manufacturing of PCBS. Type of material used for manufacturing.
- > Understand the mechanical method in manufacturing.
- ➤ Understand the basic concept of fault finding /repair and rework methods
- Acquire the basic level knowledge required to understand assembly techniques for leaded and SMDs.
- Acquire the basic level knowledge of use of various tools during assembly.
- ➤ Understand the methods of soldering of PCBs., material used in soldering process. Understand Methods of soldering.
- ➤ Understand the basic concept of SMD Soldering and understand repair and rework methods
- ➤ Understand the design and manufacturing Techniques of Printed Circuit Boards.